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ABSTRACT OF THE DISCLOSURE

Methods of manufacturing optical transceiver modules using lead frame connectors

that connect optical sub-assemblies to printed circuit boards. The lead frame connectors

include a conductive lead structure that is encased in an insert injection molded plastic casing.

The lead frame connector is aligned with the leads that protrude from the back end of the

corresponding optical sub-assembly (OSA). The leads pass through corresponding holes in

the lead frame connector and are soldered to the conductors of the lead frame assembly. Once

the soldering has been performed, the combined OSA and lead frame connector becomes a

surface mount device that can then be mounted to the PCB. Assembling an optical

transceiver using the lead frame connectors is generally less expensive and more reliable

compared to the use of conventional flexible printed circuit board connectors.

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